



40V P-Channel Enhancement Mode MOSFET

Voltage

-40 V

Current

-100 A

Features

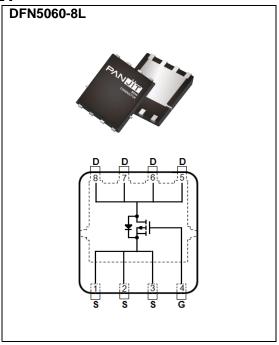
- RDS(ON), VGS@-10V, ID@-20A<6m Ω
- RDS(ON), VGS@-4.5V, ID@-10A<9.1m Ω
- 100% UIS tested
- Reliable and Rugged
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: DFN5060-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.08 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	-40	V	
Gate-Source Voltage		V _{GS}	±25] v	
Continuous Drain Current ^(Note 3)	T _C =25°C		-100		
	T _C =100°C	I _D	-70	А	
Pulsed Drain Current(Note 1)	T _C =25°C	I _{DM}	-336		
Power Dissipation	T _C =25°C	Б	107	10/	
	Tc=100°C	Po	54	W	
Continuous Drain Current(Note 4)	T _A =25°C		-17.6	Δ.	
	T _A =70°C	I _D	-14.7	_ A	
Power Dissipation	T _A =25°C	PD	3.3	W	
	T _A =70°C	PU	2.3	VV	
Single Pulse Avalanche Energy ^(Note 5)		Eas	182	mJ	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~175	°C	
Thermal Resistance ^(Note 4)	Junction to Case	R _{0JC}	1.4	°C/W	
	Junction to Ambient	$R_{\theta JA}$	45		





Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static	•			•		•	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{DSS} V _{GS} =0V, I _D =-250uA		-	-		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250uA	-1	-2	-2.5	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-20A	-	4.8	6	mΩ	
		V _{GS} =-4.5V, I _D =-10A	-	7	9.1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-40V, V _{GS} =0V	-	-	-1	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±25V, V _{DS} =0V	-	-	±100	nA	
Dynamic ^(Note 6)							
Total Gate Charge	Q_g	.,	-	100	-		
Gate-Source Charge	Qgs	V _{DS} =-32V, I _D =-20A,	-	17	-	nC	
Gate-Drain Charge	Q_{gd}	V _{GS} =-10V	-	23	-		
Input Capacitance	Ciss	V 05V V 0V	-	5790	-	pF	
Output Capacitance	Coss	V _{DS} =-25V, V _{GS} =0V,	-	463	-		
Reverse Transfer Capacitance	Crss	f=1MHz	-	291	-		
Gate resistance	Rg	f=1MHz	-	11	-	Ω	
Turn-On Delay Time	td _(on)	.,	-	10	-		
Turn-On Rise Time	tr	V _{DS} =-32, I _D =-20A,	-	9	-	ns	
Turn-Off Delay Time	td _(off)	$V_{GS}=-10V$, $R_{G}=3\Omega$	-	211	-		
Turn-Off Fall Time	tf	(Note 2)	-	150	-		
Drain-Source Diode	•			•		•	
Diode Forward Current	Is	Tc=25°C	-	-	-100		
Pulsed Diode Forward Current	I _{SM}	Tc=25 C	-	-	-336	Α	
Diode Forward Voltage	V _{SD}	Is=-20A, V _G s=0V	-	-0.85	-1.3	V	
Reverse Recovery Time	Trr	V _{GS} =0V, I _S =-20A	-	19	-	ns	
Reverse Recovery Charge	Qrr	dls/dt=100A/us	_	6	-	nC	

NOTES:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. The maximum current rating is package limited.
- 4. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. The test condition is L=0.5mH, I_{AS}=-27A, V_{DD}=-30V, V_{GS}=-10V, Starting T_J=25°C.
- 6. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

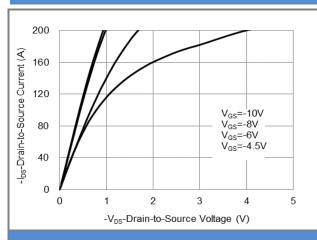


Fig.1 On-Region Characteristics

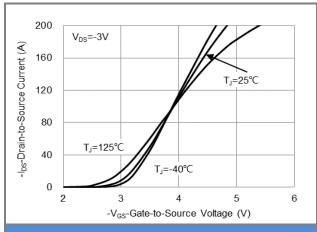


Fig.2 Transfer Characteristics

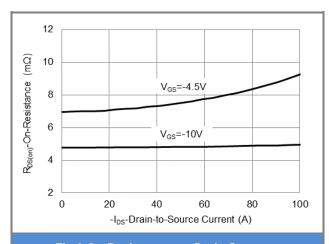


Fig.3 On-Resistance vs. Drain Current

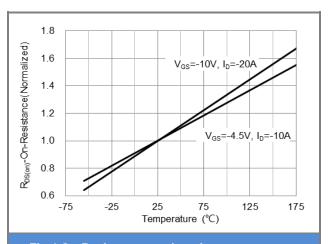


Fig.4 On-Resistance vs. Junction temperature

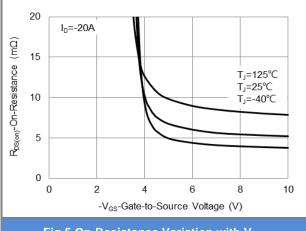


Fig.5 On-Resistance Variation with V_{GS}

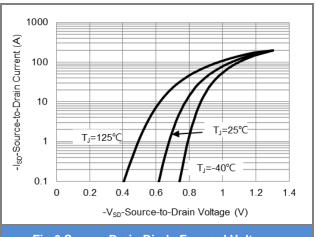


Fig.6 Source-Drain Diode Forward Voltage





TYPICAL CHARACTERISTIC CURVES

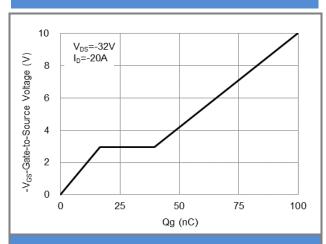


Fig.7 Gate-Charge Characteristics

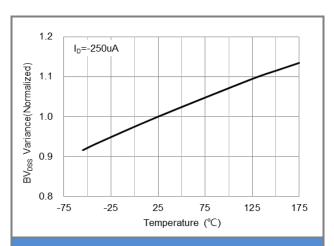


Fig.8 Breakdown Voltage Variation vs. Temperature

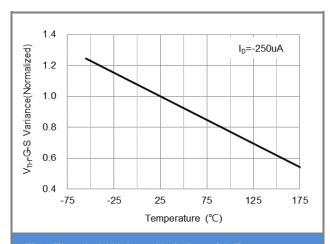


Fig.9 Threshold Voltage Variation with Temperature

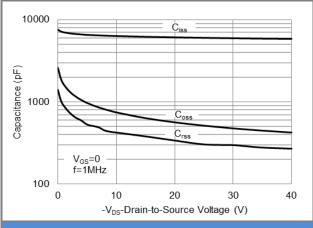
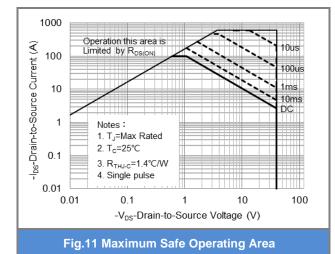


Fig.10 Capacitance vs. Drain-Source Voltage



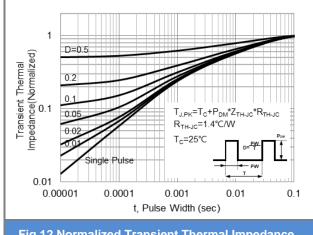


Fig.12 Normalized Transient Thermal Impedance

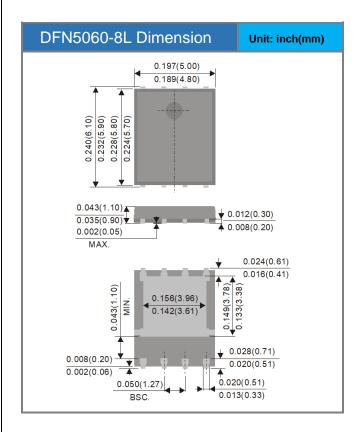


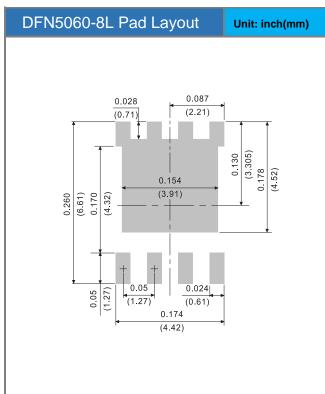


Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PJQ5449E-AU	DFN5060-8L	3K pcs / 13" reel	Q5449E

Packaging Information & Mounting Pad Layout









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